

N-Channel Enhancement Mode MOSFET

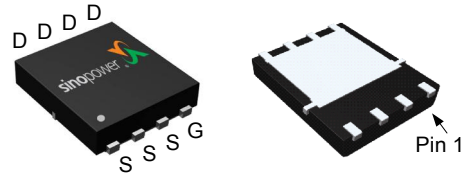
Features

- 30V/49A,
 $R_{DS(ON)} = 8.5m\Omega$ (max.) @ $V_{GS}=10V$
 $R_{DS(ON)} = 12m\Omega$ (max.) @ $V_{GS}=4.5V$
- Provide Excellent Qgd x Rds-on
- 100% UIS + R_g Tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

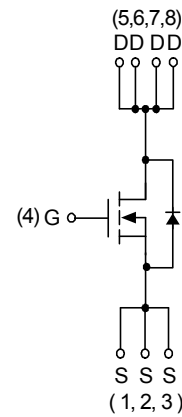
Applications

- Power Management in Desktop Computer or DC/DC Converters.

Pin Description




DFN5x6A-8_EP



N-Channel MOSFET

Ordering and Marking Information

<p>SM4378NS □□□-□□□</p> <div style="margin-left: 20px;"> <p>└─ Assembly Material</p> <p>└─ Handling Code</p> <p>└─ Temperature Range</p> <p>└─ Package Code</p> </div>	<p>Package Code KP : DFN5x6A-8_EP</p> <p>Operating Junction Temperature Range C : -55 to 150 °C</p> <p>Handling Code TR : Tape & Reel</p> <p>Assembly Material G : Halogen and Lead Free Device</p>
<p>SM4378NS KP :</p> <div style="border: 1px solid black; padding: 2px; display: inline-block;">  </div>	<p>XXXXX - Lot Code</p>

Note : SINOPOWER lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. SINOPOWER lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. SINOPOWER defines “Green” to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

SINOPOWER reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
Common Ratings			
V_{DSS}	Drain-Source Voltage	30	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	
I_S	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ 20	A
I_D	Continuous Drain Current	$T_C=25^\circ\text{C}$ 49	
		$T_C=100^\circ\text{C}$ 31	
I_{DM}^a	Pulsed Drain Current	$T_C=25^\circ\text{C}$ 123	
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$ 31	W
		$T_C=100^\circ\text{C}$ 12.5	
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State 3.9	$^\circ\text{C/W}$
I_D	Continuous Drain Current	$T_A=25^\circ\text{C}$ 14.4	A
		$T_A=70^\circ\text{C}$ 11.6	
I_{DM}^a	Pulsed Drain Current	$T_A=25^\circ\text{C}$ 57.6	A
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$ 2.7	W
		$T_A=70^\circ\text{C}$ 1.7	
$R_{\theta JA}^b$	Thermal Resistance-Junction to Ambient	$t \leq 10\text{s}$ 20	$^\circ\text{C/W}$
		Steady State 47	
I_{AS}^c	Avalanche Current, Single pulse	$L=0.1\text{mH}$ 20	A
E_{AS}^c	Avalanche Energy, Single pulse	$L=0.1\text{mH}$ 20	mJ

Note a : Pulse width is limited by maximum junction temperature.

Note b : Surface mounted on 1in^2 pad area, steady state $t = 100\text{s}$.

Note c : UIS tested and pulse width are limited by maximum junction temperature 150°C (initial temperature $T_J=25^\circ\text{C}$).

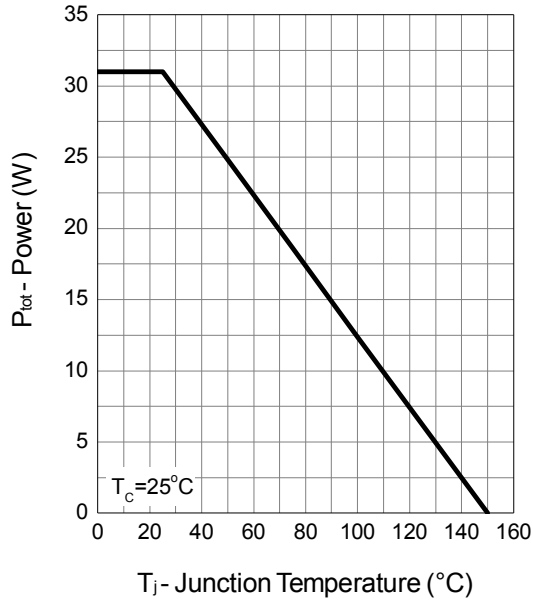
Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	30	-	-	V
$BV_{DSS(t)}$	Drain-Source Breakdown Voltage (transient)	$V_{GS}=0V, I_{D(aval)}=15A$ $T_{case}=25^\circ\text{C}, t_{transient}=100ns$	34	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=24V, V_{GS}=0V$	-	-	1	μA
		$T_J=85^\circ\text{C}$	-	-	30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	1.5	1.8	2.5	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
$R_{DS(ON)}^d$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=20A$	-	7	8.5	m Ω
		$T_J=125^\circ\text{C}$	-	10.5	-	
		$V_{GS}=4.5V, I_{DS}=10A$	-	9.2	12	
Gfs	Forward Transconductance	$V_{DS}=5V, I_{DS}=10A$	-	40	-	S
Diode Characteristics						
V_{SD}^d	Diode Forward Voltage	$I_{SD}=15A, V_{GS}=0V$	-	0.84	1.1	V
t_{rr}	Reverse Recovery Time	$I_{SD}=20A, di_{SD}/dt=100A/\mu s$	-	12.1	-	ns
t_a	Charge Time		-	6.9	-	
t_b	Discharge Time		-	5.3	-	
Q_{rr}	Reverse Recovery Charge		-	4.9	-	
Dynamic Characteristics						
R_G	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1MHz$	0.3	0.9	2	Ω
C_{iss}	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=15V,$ Frequency=1.0MHz	760	930	1100	pF
C_{oss}	Output Capacitance		100	147	200	
C_{riss}	Reverse Transfer Capacitance		65	94	120	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=15V, R_L=15\Omega,$ $I_{DS}=1A, V_{GEN}=10V,$ $R_G=6\Omega$	-	12	18	ns
t_r	Turn-on Rise Time		-	10	15	
$t_{d(OFF)}$	Turn-off Delay Time		-	24	40	
t_f	Turn-off Fall Time		-	5.5	8	
Gate Charge Characteristics						
Q_g	Total Gate Charge	$V_{DS}=15V, V_{GS}=4.5V,$ $I_{DS}=20A$	-	8	12	nC
Q_g	Total Gate Charge	$V_{DS}=15V, V_{GS}=10V,$ $I_{DS}=20A$	-	16	21	
Q_{gth}	Threshold Gate Charge		-	1.3	1.8	
Q_{gs}	Gate-Source Charge		-	2.8	3.5	
Q_{gd}	Gate-Drain Charge		-	3.7	4.4	

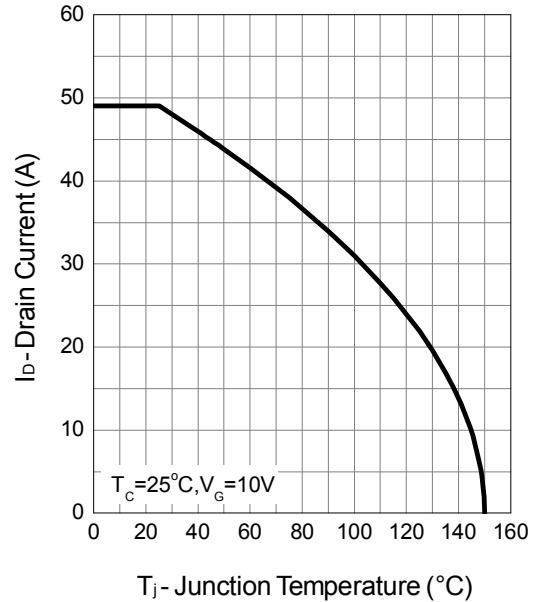
Note d : Pulse test; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

Typical Operating Characteristics

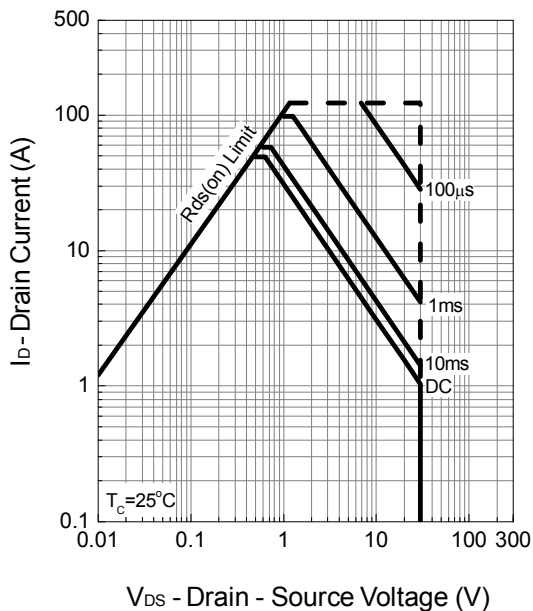
Power Dissipation



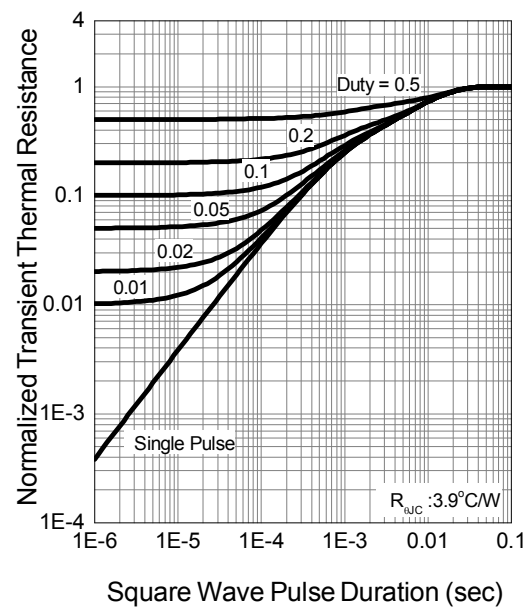
Drain Current



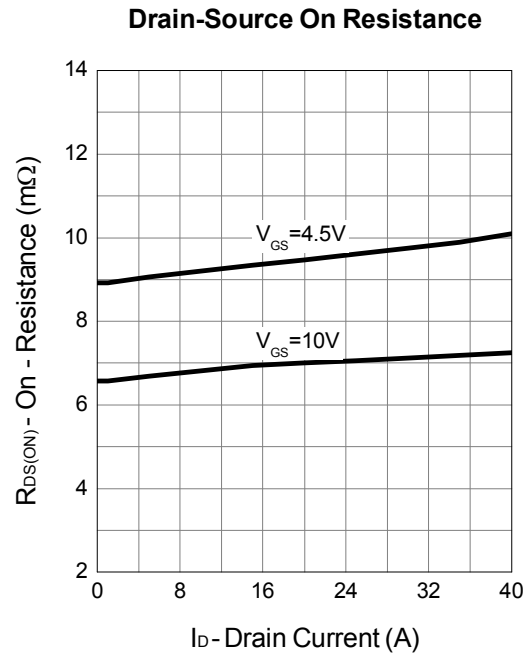
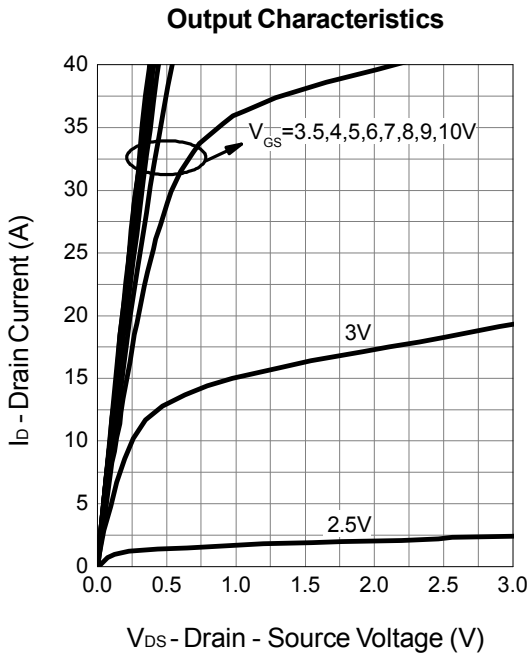
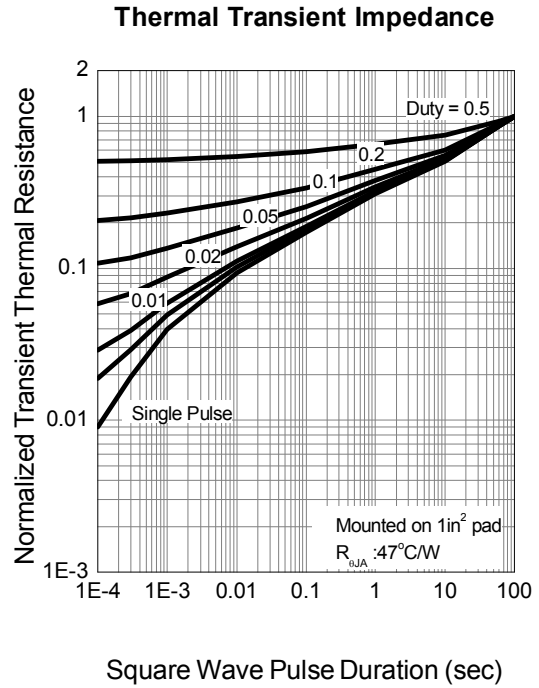
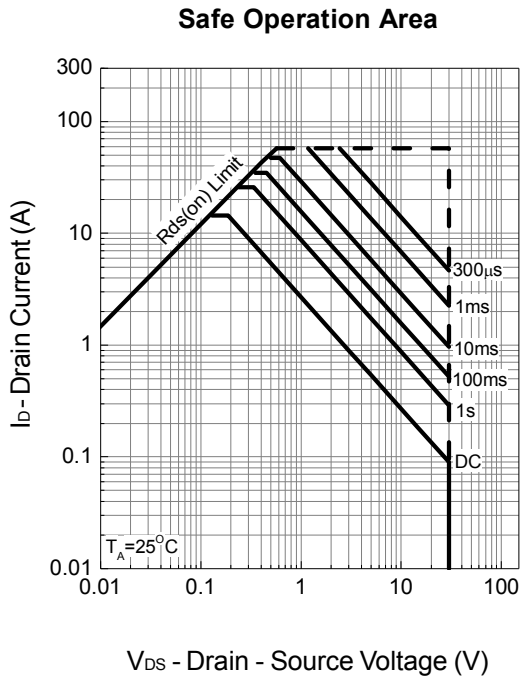
Safe Operation Area



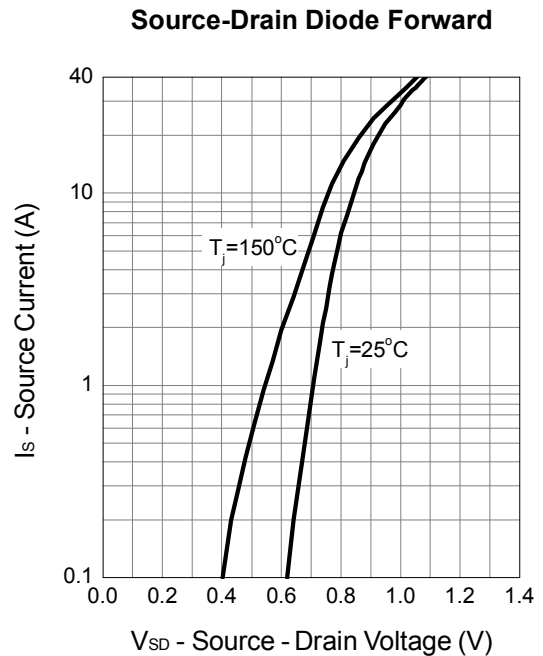
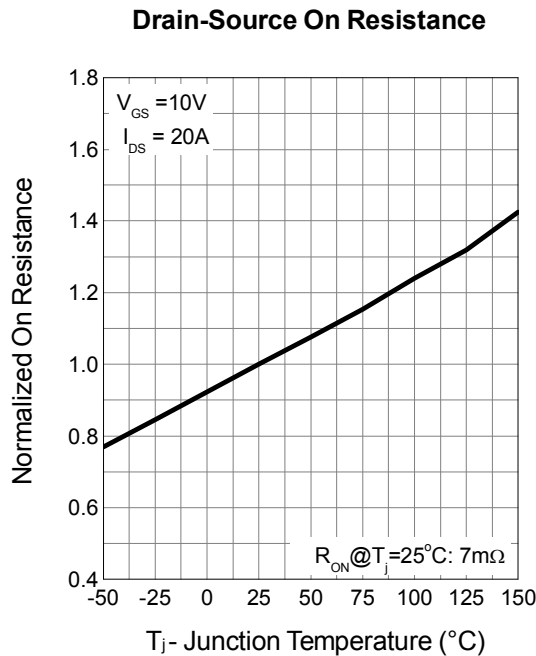
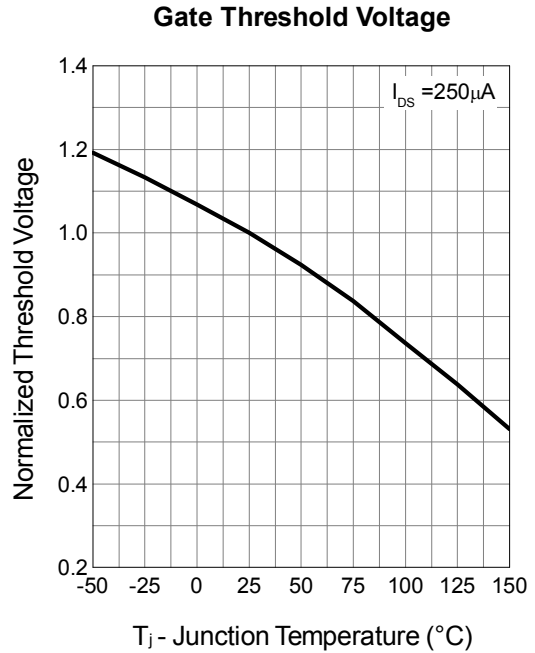
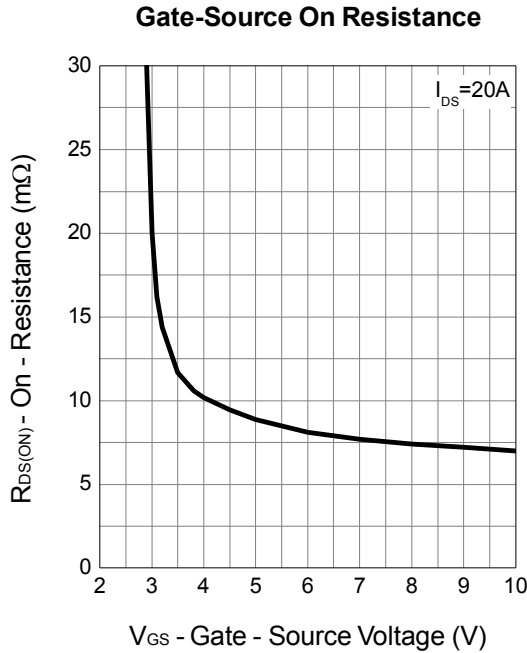
Thermal Transient Impedance



Typical Operating Characteristics (Cont.)

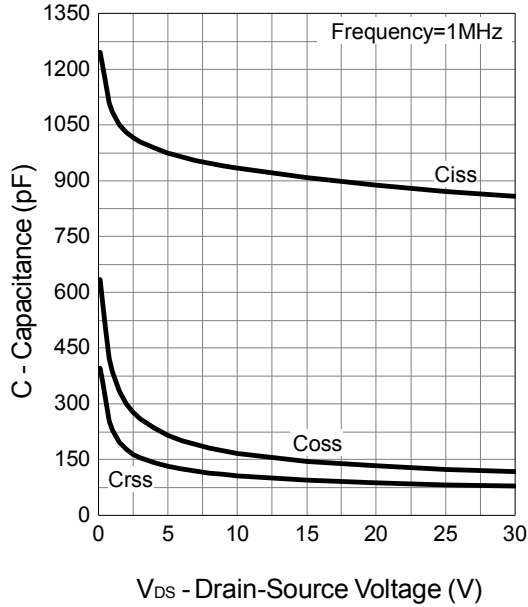


Typical Operating Characteristics (Cont.)

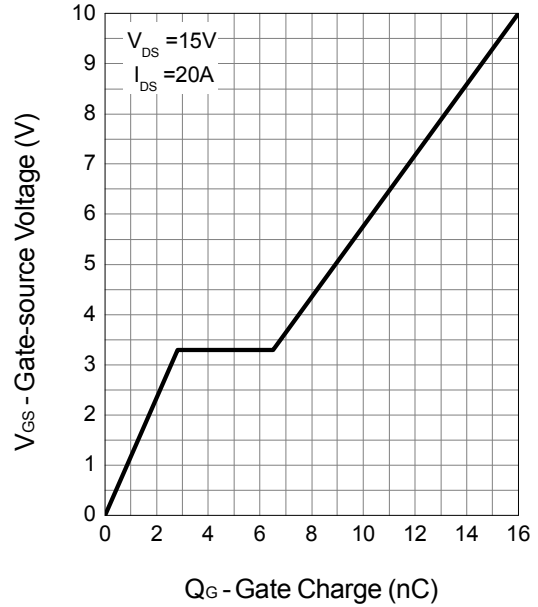


Typical Operating Characteristics (Cont.)

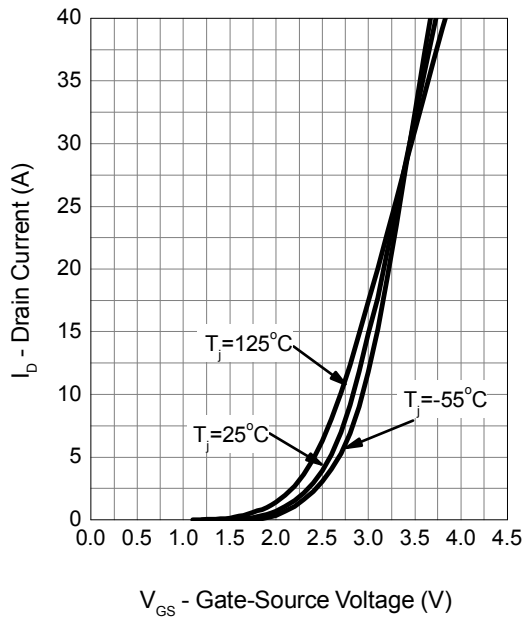
Capacitance



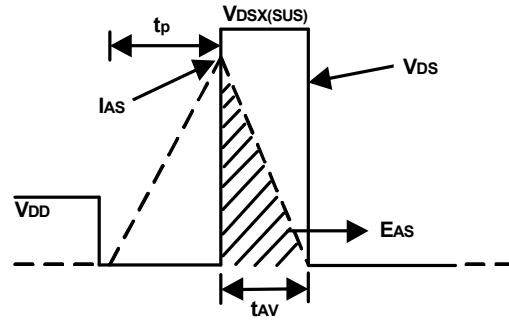
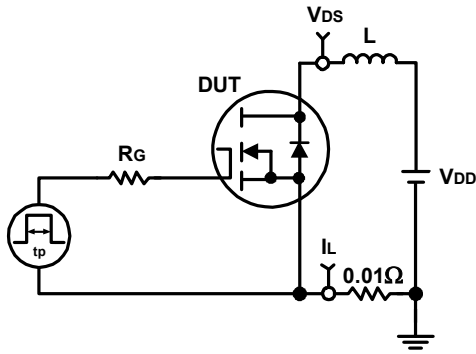
Gate Charge



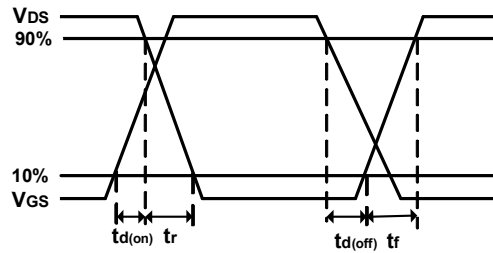
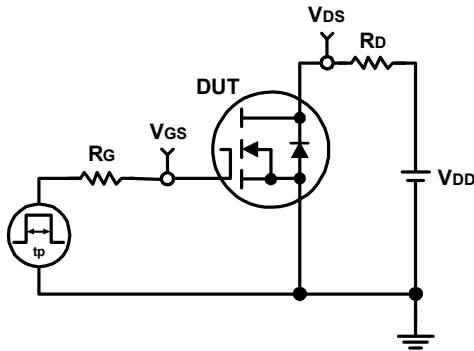
Transfer Characteristics



Avalanche Test Circuit and Waveforms



Switching Time Test Circuit and Waveforms



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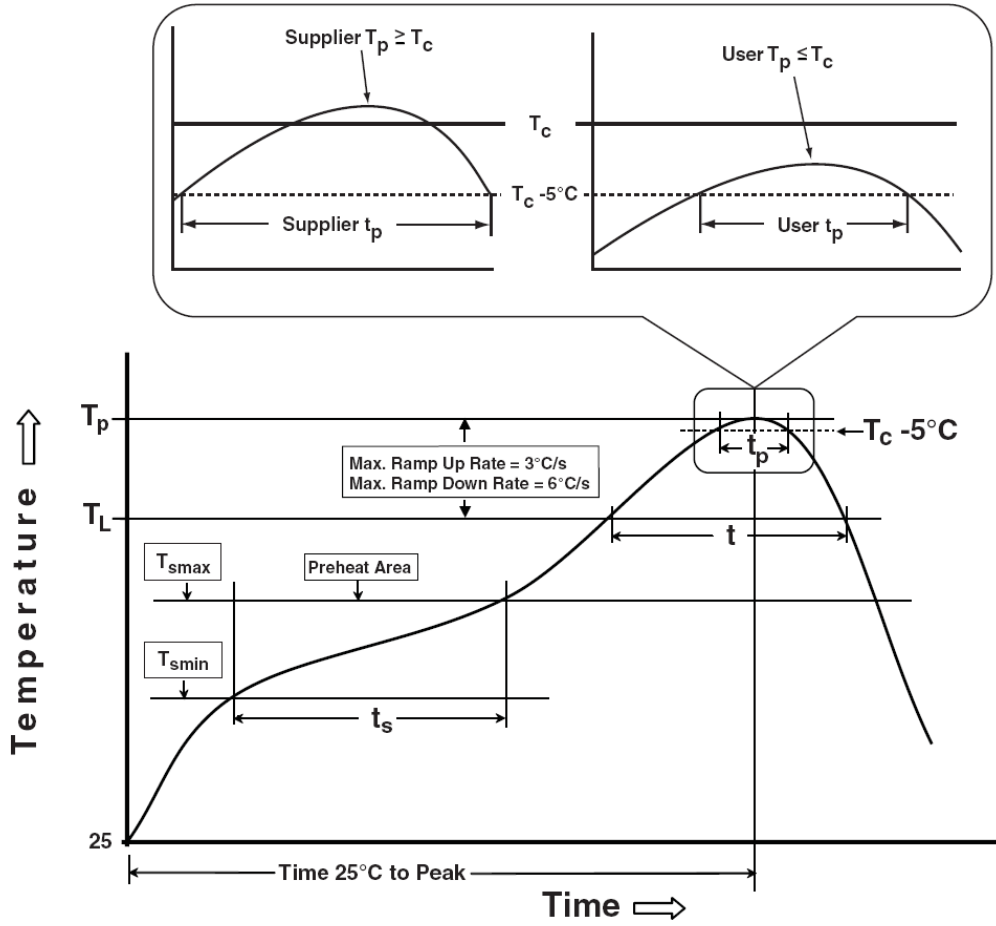
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Classification Profile



Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak		
Temperature min (T_{smin})	100 °C	150 °C
Temperature max (T_{smax})	150 °C	200 °C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max.	3°C/second max.
Liquidous temperature (T_L)	183 °C	217 °C
Time at liquidous (t_L)	60-150 seconds	60-150 seconds
Peak package body Temperature (T_p)*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t_p)** within 5°C of the specified classification temperature (T_c)	20** seconds	30** seconds
Average ramp-down rate (T_p to T_{smax})	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.		

Table 1. SnPb Eutectic Process – Classification Temperatures (T_c)

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (T_c)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	1000 Hrs, 80% of VDS max @ T_{jmax}
HTGB	JESD-22, A108	1000 Hrs, 100% of VGS max @ T_{jmax}
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -65°C~150°C

Customer Service

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